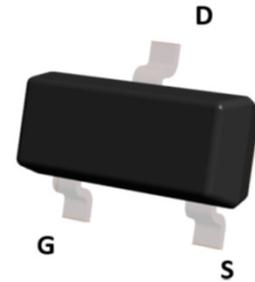
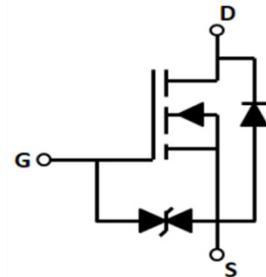
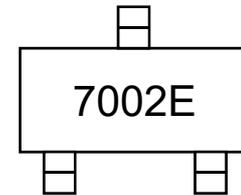


## Description

The MOSFET provide the best combination of fast switching , low on-resistance and cost-effectiveness.

- Trench Power MV MOSFET technology
- Voltage controlled small signal switch
- Low input Capacitance
- Fast Switching Speed
- Low Input / Output Leakage


**Top View**

**Circuit Diagram**

**Marking (Top View)**

MOSFET Product Summary		
$V_{DS}(V)$	$R_{DS(on)}(\Omega)$	$I_D(mA)$
60	3.0@ $V_{GS} = 10V$	300
	4.0@ $V_{GS} = 4.5V$	

## Applications

- Battery operated systems
- Solid-state relays
- Direct logic-level interface: TTL/CMOS

## Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Drain-source Voltage	$V_{DS}$	60	V
Gate-source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current <sup>1)</sup>	$I_D$	$T_A=25^\circ C$	300
		$T_A=70^\circ C$	220
Pulsed Drain Current <sup>2)</sup>	$I_{DM}$	1.2	A
Total Power Dissipation <sup>4)</sup>	$P_D$	$T_A=25^\circ C$	340
		$T_A=70^\circ C$	220
Thermal Resistance Junction-to-Ambient <sup>3)</sup>	$R_{\theta JA}$	365	$^\circ C/W$
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~+150	$^\circ C$

Notes:

1. Pulse width limited by maximum junction temperature.
2. Pulse test : Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
3. Device surface mounted on FR4 PCB measured at steady state.
4. Measured under pulsed conditions. Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .

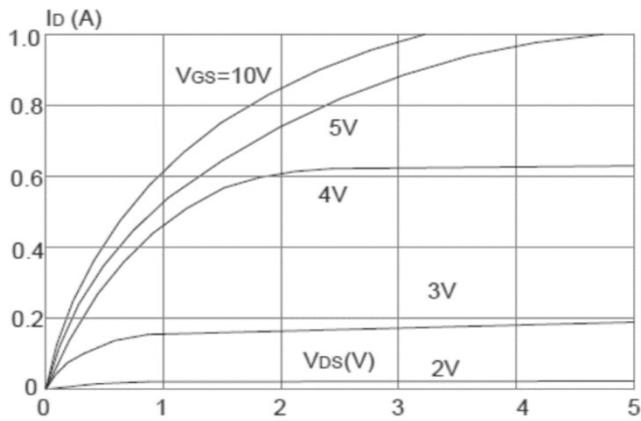
## Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	60	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1.0	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 10$	$\mu A$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.5	2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 300mA$	-	-	3.0	$\Omega$
		$V_{GS} = 4.5V, I_D = 200mA$	-	-	4.0	
Diode Forward Voltage	$V_{SD}$	$I_S = 300mA, V_{GS} = 0V$	-	0.9	1.2	V
<b>Dynamic Parameters<sup>5)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1MHz$	-	27	-	pF
Output Capacitance	$C_{oss}$		-	10	-	
Reverse Transfer Capacitance	$C_{rss}$		-	4.3	-	
<b>Switching Parameters<sup>5)</sup></b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = 30V, V_{GS} = 10V,$ $R_G = 6\Omega, I_D = 0.3A$	-	2.2	-	ns
Turn-on Rise Time	$t_r$		-	14	-	
Turn-Off Delay Time	$t_{d(off)}$		-	7.0	-	
Turn-Off Fall Time	$t_f$		-	18	-	
Total Gate Charge	$Q_g$	$V_{DS} = 10V, I_D = 0.3A,$ $V_{GS} = 4.5V$	-	1.8	-	nC
Gate-Source Charge	$Q_{gs}$		-	0.3	-	
Gate-Drain Charge	$Q_{gd}$		-	0.6	-	
Gate Resistance	$R_g$	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$	-	135	-	$\Omega$
<b>Drain-Source Diode Characteristics<sup>5)</sup></b>						
Maximum Pulsed Drain to Source Diode Forward Current	$I_{SM}$	-	-	-	1.2	A
Diode Forward Current	$I_S$	-	-	-	0.3	A

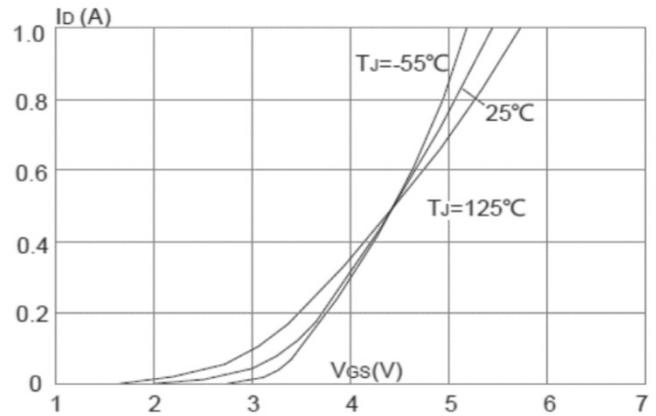
Notes:

5. Guaranteed by design, not subject to production.

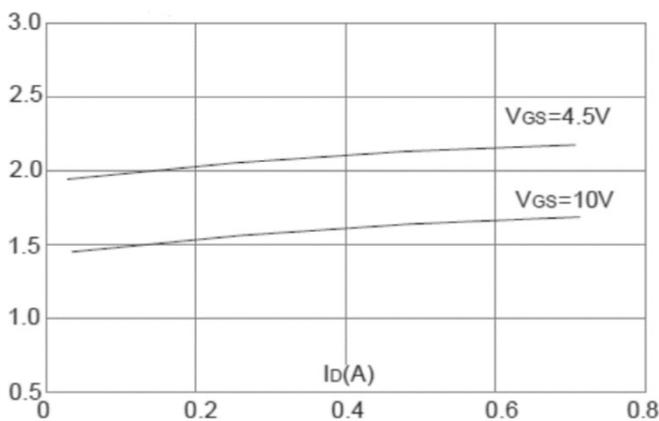
## Typical Characteristics



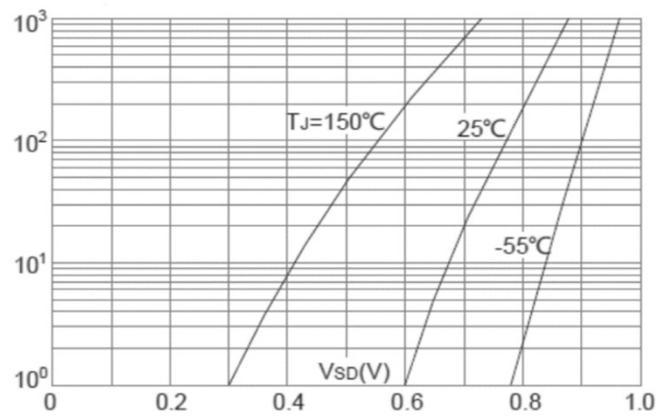
**Figure 1:** Output Characteristics



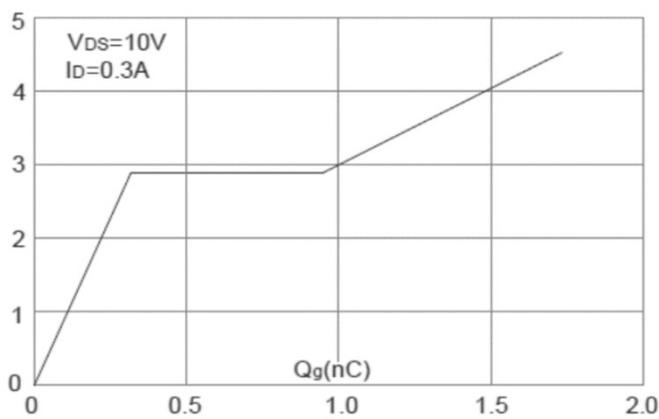
**Figure 2:** Typical Transfer Characteristics



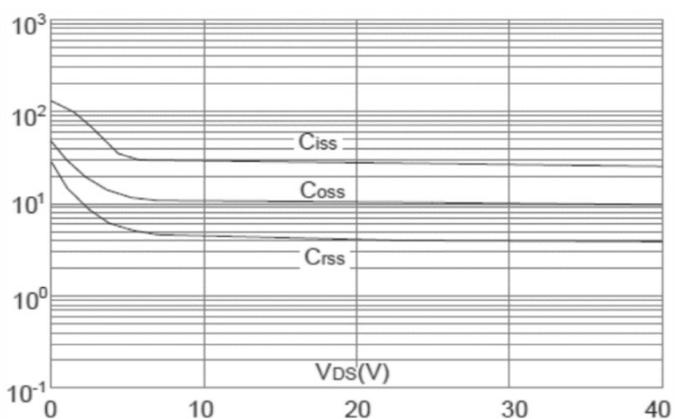
**Figure 3:** On-resistance vs. Drain Current



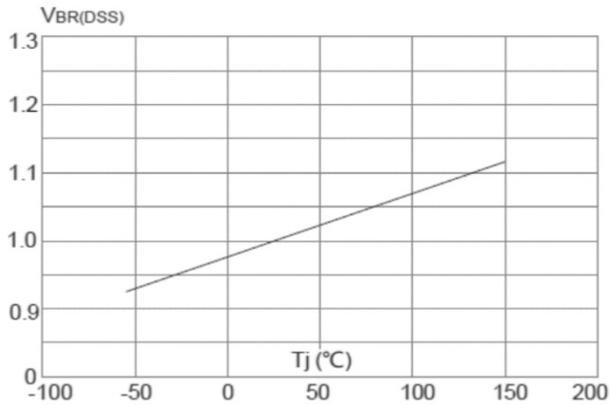
**Figure 4:** Body Diode Characteristics



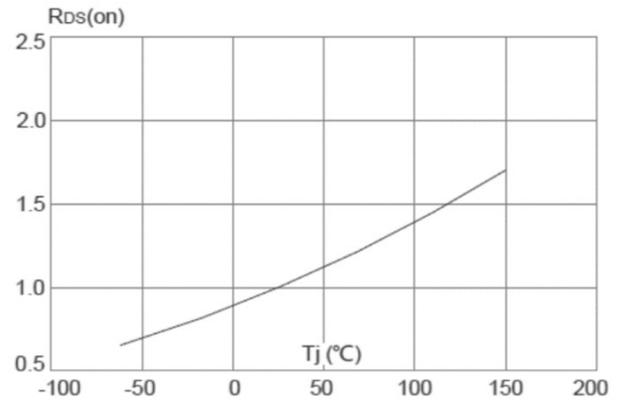
**Figure 5:** Gate Charge Characteristics



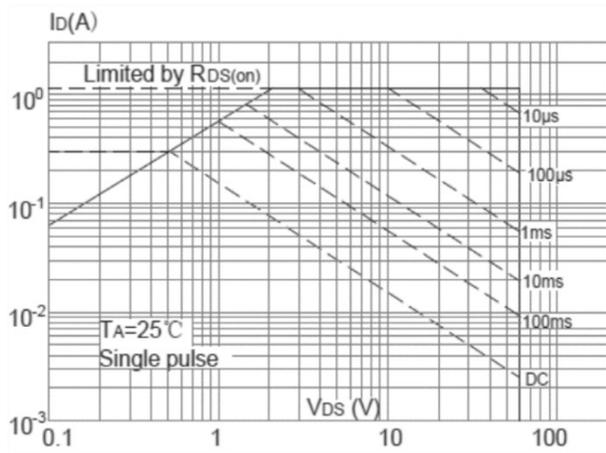
**Figure 6:** Capacitance Characteristics



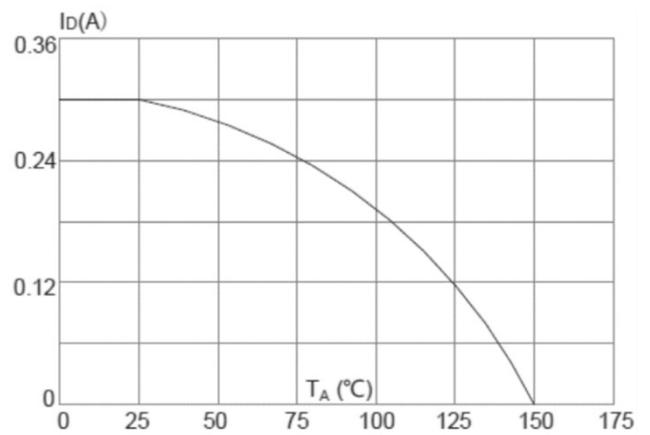
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



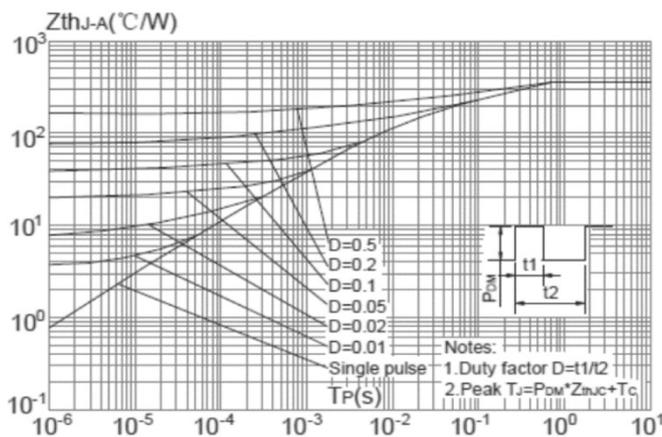
**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 9:** Maximum Safe Operating Area

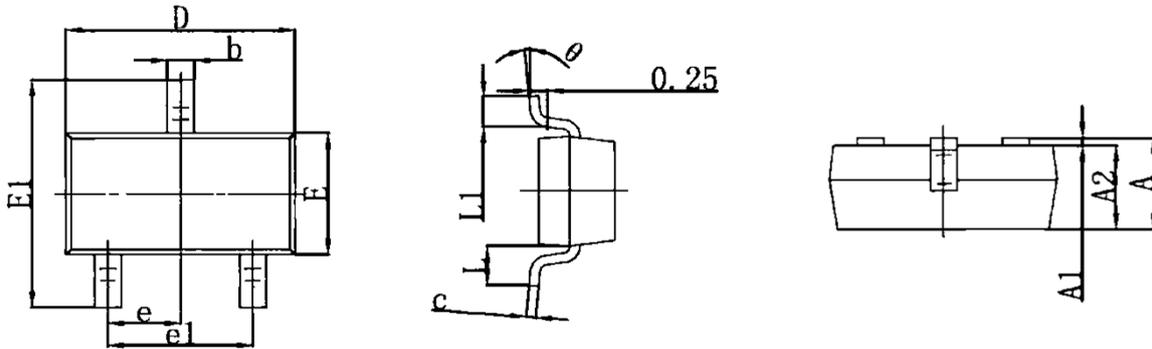


**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature

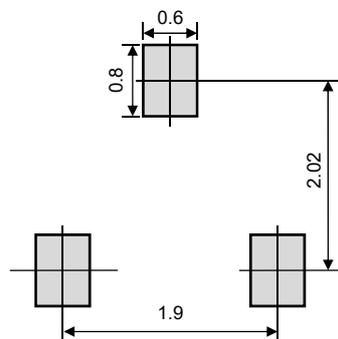


**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

## Product dimension (SOT-23)



Dim	Millimeters		Inches	
	Min	Max	Min	Max
A	-	1.50	-	0.059
A1	0.04	0.15	0.002	0.006
A2	-	1.35	-	0.053
b	0.30	0.50	0.012	0.020
c	0.08	0.21	0.003	0.008
D	2.72	3.12	0.107	0.123
E	1.10	1.50	0.043	0.059
E1	2.10	2.64	0.083	0.104
e	0.95 Typ.		0.037 Typ.	
e1	1.80	2.00	0.071	0.079
L	0.65 Ref.		0.026 Ref.	
L1	0.20	0.60	0.008	0.024
θ	0°	8°	0°	8°



Suggested PCB Layout

Unit:mm

## Ordering information

Device	Package	Reel	Shipping
PNMT7002E	SOT-23	7"	3000 / Tape & Reel

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